

VOLTAGE RANGE: 40 - 200V

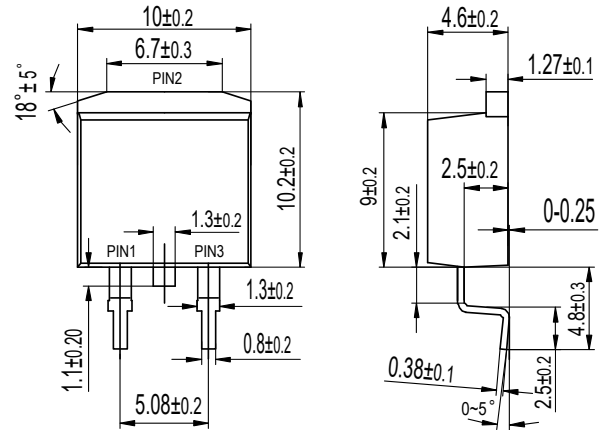
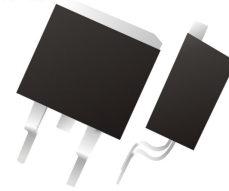
CURRENT: 30A

Features

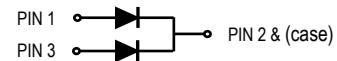
- High efficiency operation
- Low power loss
- Low stored charge majority carrier conduction
- High forward surge capability
- Lead free in compliance with EU RoHS 2011/65/EU directive
- Green molding compound as per IEC61249 Std (Halogen Free)

Mechanical Data

- Circuit figure: Single positive
- Leads: Solderable per mil-std-202, Method 208
- Polarity: as marked
- Mounting torque: 5 in-lbs maximum
- Terminals: Puretin plated
- Weight: TO-263(D²PAK) 1.35 grams



TO-263(D²PAK)



Maximum Ratings and Electrical Characteristics T_A = 25°C unless otherwise specified

RATINGS	SYMBOL	MBRB 30H40CT	MBRB 30H45CT	MBRB 30H60CT	MBRB 30H100CT	MBRB 30H150CT	MBRB 30H200CT	UNIT
Maximum repetitive reverse voltage	VRRM	40	45	60	100	150	200	V
Maximum RMS voltage	VRMS	28	32	42	70	105	140	V
Maximum DC blocking voltage	VDC	40	45	60	100	150	200	V
Maximum average forward current per device per diode	I _{AV}	30				15		A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	280						A
Typical thermal resistance (Note 1)	R _{θ-JC}	2.5						°C/W
Operating junction temperature range	T _J	-55 to +150				-55 to +175		°C
Storage temperature range	T _{STG}	-55 to +175						°C
Maximum forward voltage per leg at I _F =15A	V _F	0.65	0.75	0.85	0.95		V	
Maximum average reverse current at rated DC blocking voltage T _J =25°C T _J =125°C	I _R	0.10 15			0.01 8			mA

Notes: 1. Thermal resistance from junction to case.

FIG. 1 - TYPICAL FORWARD CURRENT DERATING CURVE

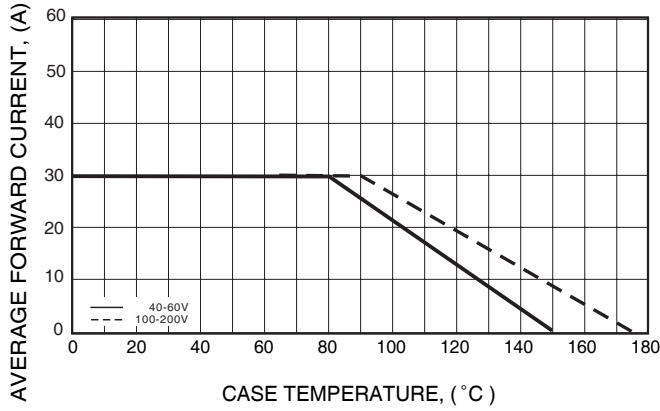


FIG. 2 - MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

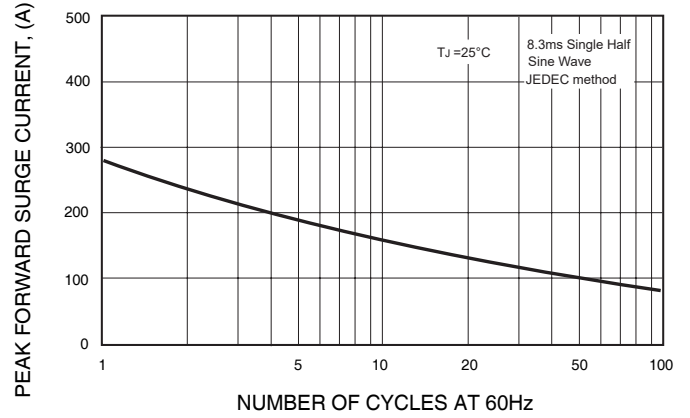


FIG. 3 - TYPICAL REVERSE CHARACTERISTICS

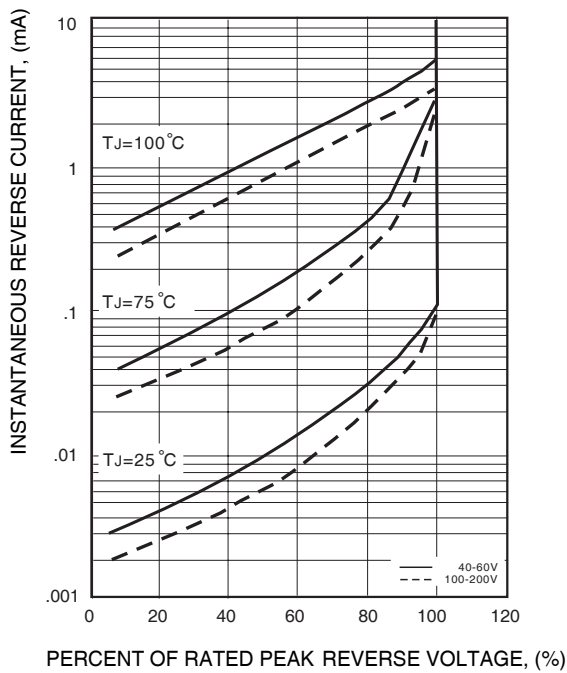


FIG. 4 - TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

